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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/651,779	08/30/2000	Scott E Moore	108298515US	2448
25096	7590	09/17/2004	EXAMINER	
PERKINS COIE LLP PATENT-SEA P.O. BOX 1247 SEATTLE, WA 98111-1247			NGUYEN, DUNG V	
			ART UNIT	PAPER NUMBER
			3723	

DATE MAILED: 09/17/2004

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary

Application No.

09/651,779

Applicant(s)

MOORE, SCOTT E

Examiner

Dung V Nguyen

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-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --
Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☒ Responsive to communication(s) filed on 14 July 2004.
2a) ☐ This action is FINAL. 2b) ☒ This action is non-final.
3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 3,6,8,32,37,38,43-48,53,55,68,69,76-95 and 98-124 is/are pending in the application.
4a) Of the above claim(s) _____ is/are withdrawn from consideration.
5) ☒ Claim(s) 6,8,32,43-48,53,55,68,69,76-81,89-95,98-104 and 114,115,117-124 is/are allowed.
6) ☒ Claim(s) 3,37,38,82,105,106,110 and 113 is/are rejected.
7) ☒ Claim(s) 83-88,107-109,111,112 and 116 is/are objected to.
8) ☐ Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
10) ☐ The drawing(s) filed on _____ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
a) ☐ All b) ☐ Some * c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
2. ☐ Certified copies of the priority documents have been received in Application No. _____.
3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).
* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- 1) ☐ Notice of References Cited (PTO-892)
2) ☐ Notice of Draftsperson's Patent Drawing Review (PTO-948)
3) ☒ Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)
Paper No(s)/Mail Date 7/14/04.
4) ☐ Interview Summary (PTO-413)
Paper No(s)/Mail Date. _____.
5) ☐ Notice of Informal Patent Application (PTO-152)
6) ☐ Other: _____.

DETAILED ACTION

Claim Objections

1. Claim 116 is objected to because of the following informalities: depend on a canceled claim 25. Appropriate correction is required.

Claim Rejections - 35 USC § 102

2. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

3. Claims 3, 82, 105, 37, 38, 106, 110 and 113 are rejected under 35 U.S.C. 102(b) as being anticipated by Kishii et al (USPN 5,562,529). Kishii et al discloses a method for removing an electrically conductive material from a microelectronic substrate 53 comprising positioning a first conductive electrode 45a proximate to a first portion of the microelectronic substrate 53, positioning a second conductive electrode 45b proximate to the first portion of microelectronic substrate 53 and spaced apart from the first conductive electrode 45a, removing the conductive material from the first portion of the microelectronic substrate 53 by passing a varying current through the first and second electrodes 45 while the first and second electrodes 45 are spaced apart from the conductive material of the microelectronic substrate 53, moving the microelectronic substrate 53 or the electrodes 45 relative to the other, removing the conductive material from the second portion of the microelectronic substrate by applying a varying current to the first and second electrodes 45 while the first and second electrodes 45 are spaced

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apart from the conductive material of the microelectronic substrate 53, directing a first flow of electrolyte only to the first portion of the microelectronic substrate when the electrode pair is proximate to the first portion and directing a second flow of electrolyte to the second portion of the microelectronic substrate when the electrodes are proximate to the second portion, disposing a liquid between the electrode 45 and the microelectronic substrate 53, contacting the microelectronic substrate 53 with a polishing pad 43 while moving the microelectronic substrate 53 or the electrodes 45 relative to the other (note Fig. 10 and 11, col. 8, line 23 to col. 9, line 20).

Allowable Subject Matter

4. Claims 6, 8, 32, 53, 55, 68, 69, 76-81, 89-93, 94, 95, 98-104, 114, 115 and 117-124 are allowed.

5. Claims 83-88, 107-109, 111 and 112 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

Response to Arguments

6. Applicant's arguments with respect to claims have been considered but are moot in view of the new ground(s) of rejection.

Conclusion

7. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Dung V Nguyen whose telephone number is 703-305-0036. The examiner can normally be reached on M-F, 6:30-3:00.

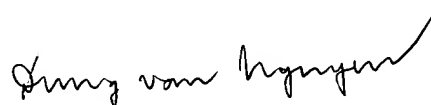
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8. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Joseph J Hail can be reached on 703-308-2687. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

9. Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

DVN

September 14, 2004



**DUNG VAN NGUYEN
PRIMARY EXAMINER**